Application Number:	Application Fee Transmittal				
	10788505				
Filing Date:	26-Feb-2004				
Title of Invention:	Thin profile battery bonding method, method of conductively interconnecting electronic components, battery powerable apparatus, radio frequency communication device, and electric circuit				
First Named Inventor/Applicant Name:	Rickie C. Lake				
Filer:	John Patrick Ward/Anne Collette				
Attorney Docket Number:	076838-106703/US				
Filed as Large Entity					
Utility Filing Fees					
Description	Fee Code	Quantity	Amount	Sub-Total ir USD(\$)	
Basic Filing:					
Pages:			Δ.,,		
Claims:					
Claims in excess of 20	1202	4	50	200	
Independent claims in excess of 3	1201	1	210	210	
Miscellaneous-Filing:	•				
Petition:					
Patent-Appeals-and-Interference:					

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Extension-of-Time:				
Miscellaneous:				
	Total in USD (\$)			410